

**SEMICONDUCTOR COMPONENT HAVING AT LEAST TWO CHIPS
WHICH ARE INTEGRATED IN A HOUSING AND WITH WHICH
5 CONTACT IS MADE BY A COMMON CONTACT CHIP**

Abstract

A semiconductor component, featuring a housing, at least two semiconductor chips arranged in the housing, which chips in each case have a 10 front side and a rear side and in each case have at least one contact area at the front and/or rear side, at least one contact clip, which projects from the housing, within the housing, and which has a plate-type section with a first and a second connection area which are opposite one another, and which makes contact with at least two of the chips, its first connection area being applied to the contact 15 area of at least one of the chips and its second connection area being applied to the contact area of at least another of the chips.